



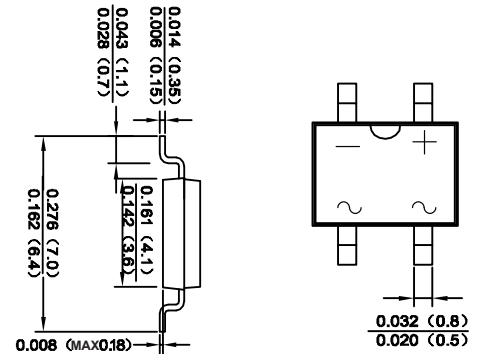
MB05F THRU MB10F

Voltage Range - 50 to 1000 Volts Current - 0.8 Ampere

SINGLE PHASE GLASS PASSIVATED BRIDGE RECTIFIERS

Features

- ◆ Glass passivated die construction
- ◆ Low forward voltage drop
- ◆ High current capability
- ◆ High surge current capability
- ◆ Designed for surface mount application
- ◆ Plastic material-UL flammability 94V-0



Mechanical Data

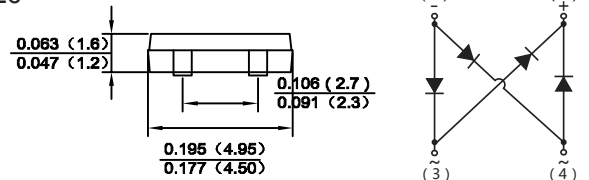
Case : JEDEC MBF Molded plastic body

Terminals : Solder plated, solderable per MIL-STD-750, Method 2026

Polarity : Polarity symbol marking on body

Mounting Position : Any

Weight : 0.0026 ounce, 0.075 grams



Maximum Ratings And Electrical Characteristics

Dimensions in inches and (millimeters)

Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	MDD	MDD	MDD	MDD	MDD	MDD	MDD	UNITS
		MB05F	MB1F	MB2F	MB4F	MB6F	MB8F	MB10F	
Marking Code									
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at $T_c=30^\circ\text{C}$ On glass-epoxy P.C.B. On aluminum substrate	$I_{F(AV)}$	0.5 0.8							A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	30							A
Maximum instantaneous forward voltage drop per leg at 1A	V_F	1.1							V
Maximum DC reverse current at rated DC blocking voltage $T_A=25^\circ\text{C}$ $T_A=100^\circ\text{C}$	I_R	5 500							μA
Typical junction capacitance NOTE3	C_J	13							pF
Typical thermal resistance	$R_{\theta JA}$	60							$^\circ\text{C/W}$
Operating temperature range	T_J	-55 to +150							$^\circ\text{C}$
storage temperature range	T_{STG}	-55 to +150							$^\circ\text{C}$

NOTES: 1. On glass epoxy P.C.B. mounted on 0.05x0.05"(1.3x1.3mm) pads
2. On aluminum substrate P.C.B. with on area of 0.8"x0.8"(20x20mm) mounted on 0.05x0.05"(1.3x1.3mm) solder pad
3. Measured at 1.0MHz and applied reverse voltage of 4.0 volts.



Ratings And Characteristic Curves

Fig. 1 Output Current Derating Curve

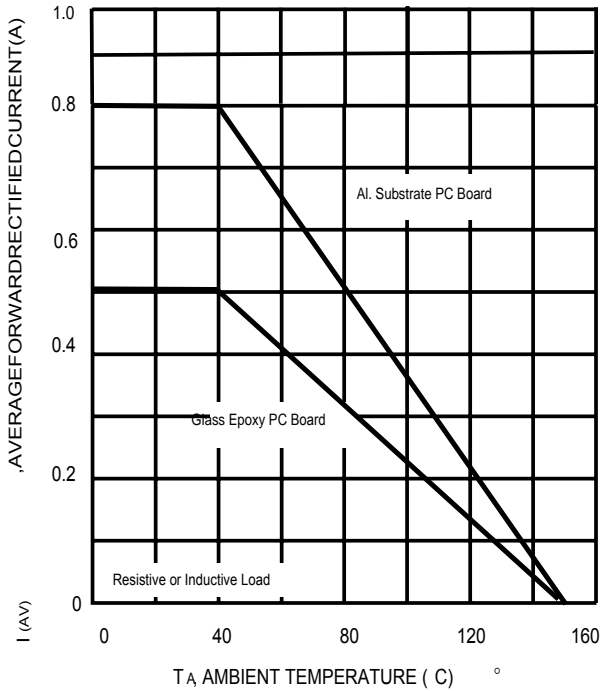


Fig. 2 Typical Forward Characteristics (per leg)

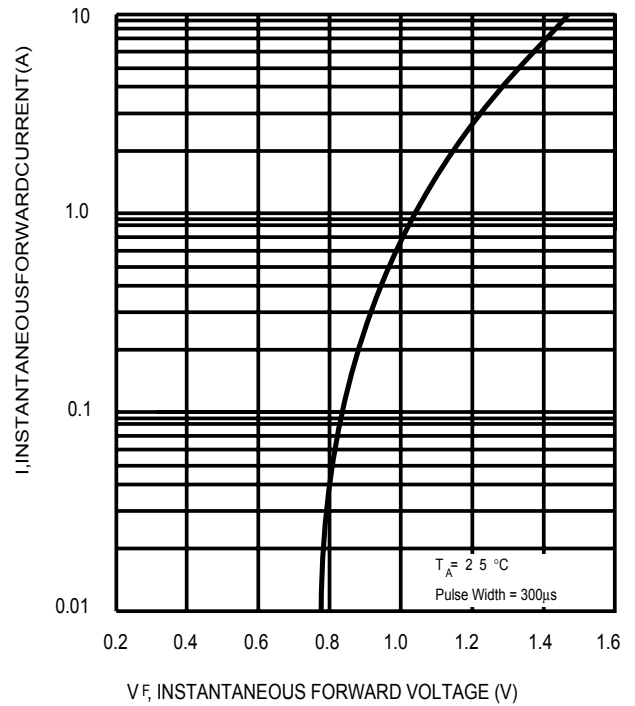


Fig. 3 Maximum Peak Forward Surge Current (per leg)

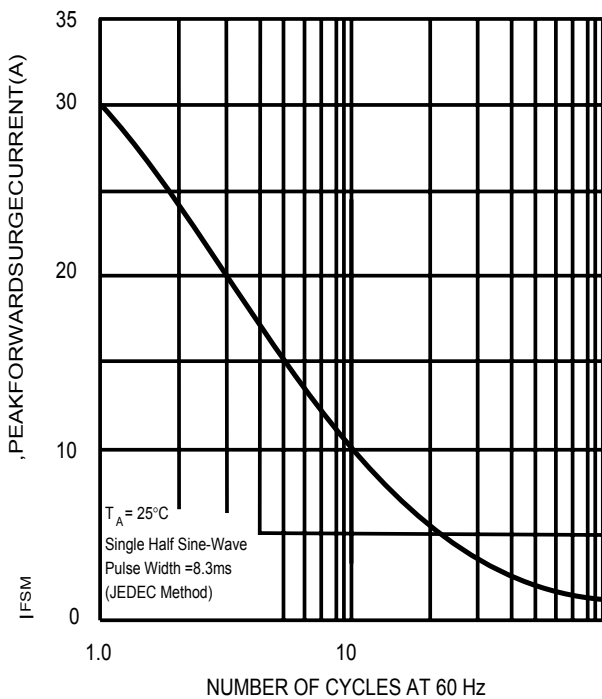
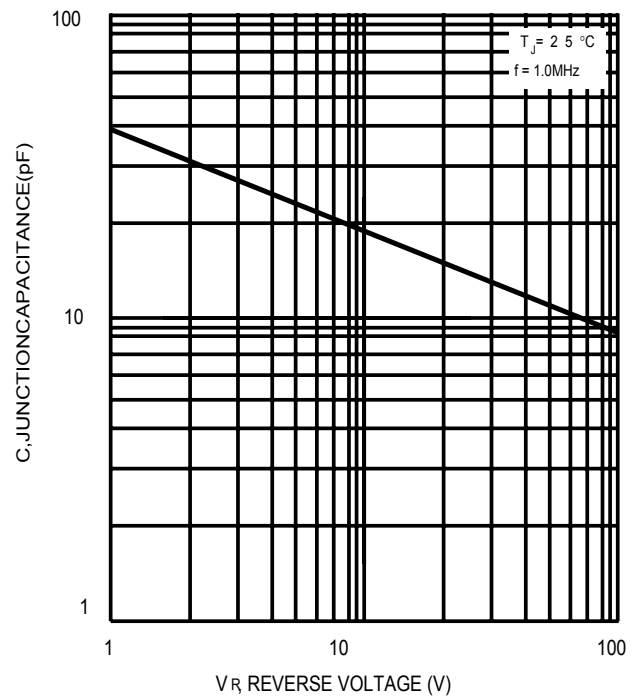


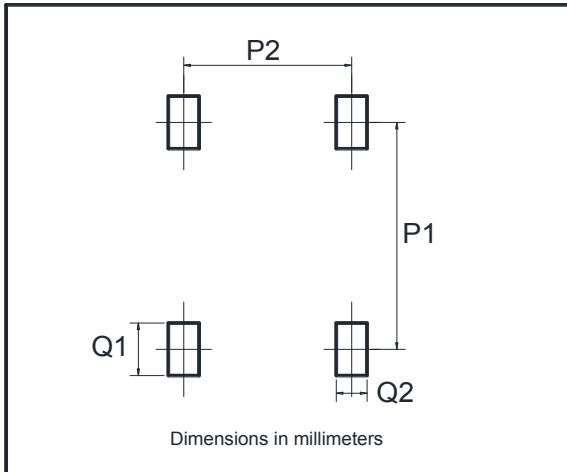
Fig. 4 Typical Junction Capacitance



The curve above is for reference only.



Suggested Pad Layout



Dim	Min
P1	6.00
P2	2.40
Q1	1.84
Q2	1.20

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